

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT3023398

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	CHIA-HUA HO	09/05/2014
	SHUO-CHE CHANG	09/05/2014
	HSIU-HAN LIAO	09/05/2014
	PO-YEN HSU	09/05/2014
	MENG-HUNG LIN	09/05/2014
	BO-LUN WU	09/05/2014
	TING-YING SHEN	09/05/2014
<b>RECEIVING PARTY DATA</b>		
<b>Name:</b>	WINBOND ELECTRONICS CORP.	
<b>Street Address:</b>	NO. 8 KEYA 1ST RD., DAYA DISTRICT, CENTRAL TAIWAN SCIENCE PARK,	
<b>City:</b>	TAICHUNG CITY	
<b>State/Country:</b>	TAIWAN	
<b>PROPERTY NUMBERS Total: 1</b>		
	<b>Property Type</b>	<b>Number</b>
	Application Number:	14481925
<b>CORRESPONDENCE DATA</b>		
<b>Fax Number:</b>	(510)580-7280	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
<b>Email:</b>	USA@JCIPGroup.com.tw	
<b>Correspondent Name:</b>	JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE	
<b>Address Line 1:</b>	7F.-1, NO. 100, ROOSEVELT RD., SEC. 2,	
<b>Address Line 4:</b>	TAIPEI, TAIWAN 100	
<b>ATTORNEY DOCKET NUMBER:</b>	51478-US-PA	
<b>NAME OF SUBMITTER:</b>	BELINDA LEE	
<b>SIGNATURE:</b>	/Belinda Lee/	
<b>DATE SIGNED:</b>	09/14/2014	
<b>Total Attachments: 4</b>		
source=51478us_DecAssgn#page1.tif		

PATENT

source=51478us\_DecAssgn#page2.tif

source=51478us\_DecAssgn#page3.tif

source=51478us\_DecAssgn#page4.tif

**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

☒ Declaration Submitted With Initial Filing

OR

☐ Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)

(Title of the Invention)

**RESISTIVE RANDOM ACCESS MEMORY AND METHOD OF  
FABRICATING THE SAME**

As a below named inventor (hereinafter designated as the undersigned), I hereby  
declare that:

This declaration is directed to:

☒ The attached application,

OR

☐ United States Application Number or PCT International application number

\_\_\_\_\_ Filed on \_\_\_\_\_

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in  
the application.

**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS 1. Winbond Electronics Corp.  
of No. 8 Keya 1st Rd., Daya District, Central Taiwan Science Park,  
Taichung City, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: Chia-Hua Ho Date: September 5, 2014

Legal Name of Sole or First Inventor: Chia-Hua Ho

Residence: Taichung City, Taiwan

Mailing Address: c/o No. 8 Keya 1st Rd., Daya District, Central Taiwan Science Park, Taichung City,  
Taiwan, R.O.C.

Signature: Shuo-che Chang Date: September 5, 2014

Legal Name of Additional Joint Inventor, if any: Shuo-Che Chang

Residence: Taichung City, Taiwan

Mailing Address: c/o No. 8 Keya 1st Rd., Daya District, Central Taiwan Science Park, Taichung City,  
Taiwan, R.O.C.

Signature: Hsiu-Han Liao Date: September 5, 2014

Legal Name of Additional Joint Inventor, if any: Hsiu-Han Liao

Residence: Hsinchu City, Taiwan

Mailing Address: No. 150, Aly. 122, Minghu Rd., East Dist., Hsinchu City 300, Taiwan (R.O.C.)

Signature: Po-Yen Hsu Date: September 5, 2014

Legal Name of Additional Joint Inventor, if any: Po-Yen Hsu

Residence: New Taipei City, Taiwan

Mailing Address: 3F., No.11, Aly. 16, Ln. 35, Baoqing St., Xindian Dist., New Taipei City 231, Taiwan  
(R.O.C.)

Signature: Meng-Heng Lin Date: September 5, 2014

Legal Name of Additional Joint Inventor, if any: Meng-Heng Lin

Residence: Taichung City, Taiwan

Mailing Address: No.60, Dongren St., Fengyuan Dist., Taichung City 420, Taiwan (R.O.C.)

Signature: Bo-Lun Wu Date: September 5, 2014

Legal Name of Additional Joint Inventor, if any: Bo-Lun Wu

Residence: Changhua County, Taiwan

Mailing Address: No.116, Yixin St., Tianzhong Township, Changhua County 520, Taiwan (R.O.C.)

103-007  
51478-US-PA

**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: Ting Ying Shen Date: September 5, 2014

Legal Name of Additional Joint Inventor, if any: Ting-Ying Shen

Residence: Chiayi City, Taiwan

Mailing Address: No.21, Ln. 188, Wufeng S. Rd., East Dist., Chiayi City 600, Taiwan (R.O.C.)